Key Parameters

V_{DSM} = 6500 V
I_{TAVM} = 4200 A
I_{TRMS} = 6594 A
I_{TSM} = 67500 A
V_{T0} = 1.13 V
r_T = 0.185 mΩ

Phase Control Thyristor
5STP 42U6500

Doc. No. 5SYA 1043-01 August, 00

Features

- **Patented free-floating silicon technology**
- **Low on-state and switching losses**
- **Designed for traction, energy and industrial applications**
- **Optimum power handling capability**
- **Interdigitated amplifying gate.**

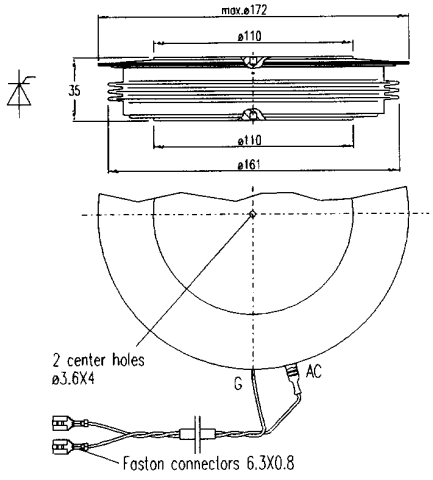
Blocking

Part Number	**5STP 42U6500**	**5STP 42U6200**	**5STP 42U5800**	Conditions	
V_{DSM} V_{RSM}	6500 V	6200 V	5800 V	f = 5 Hz, t_p = 10ms	
V_{DRM} V_{RRM}	5600 V	5300 V	4900 V	f = 50 Hz, t_p = 10ms	
V_{RSM1}	7000 V	6700 V	6300 V	t_p = 5 ms, single pulse	
I_{DSM}	≤ 700 mA			V_{DSM}	T_j = 125°C
I_{RSM}	≤ 700 mA			V_{RSM}	
dV/dt_{crit}	2000 V/µs			@ Exp. to 0.67xV_{DRM}	

V_{DRM}/ V_{RRM} are equal to V_{DSM}/ V_{RSM} values up to T_j = 110°C

Mechanical data

F_M	Mounting force	nom.	135	kN
		min.	120	kN
		max.	160	kN
a	Acceleration			
	Device unclamped		50	m/s^2
	Device clamped		100	m/s^2
m	Weight		3.6	kg
D_S	Surface creepage distance		55	mm
D_a	Air strike distance		23	mm



On-state

I_{TAVM}	Max. average on-state current	4200 A	Half sine wave, T_C = 70°C	
I_{TRMS}	Max. RMS on-state current	6594 A		
I_{TSM}	Max. peak non-repetitive surge current	67500 A	tp = 10 ms	T_j = 125°C
		72000 A	tp = 8.3 ms	After surge:
I^2t	Limiting load integral	22780 kA^2s	tp = 10 ms	$V_D = V_R$ = 0V
		21600 kA^2s	tp = 8.3 ms	
V_T	On-state voltage	1.73 V	I_T = 3000 A	
V_{T0}	Threshold voltage	1.13 V	I_T = 2000 - 6000 A	T_j = 125°C
r_T	Slope resistance	0.185 mΩ		
I_H	Holding current	50-200 mA	T_j = 25°C	
		30-100 mA	T_j = 125°C	
I_L	Latching current	150-900 mA	T_j = 25°C	
		100-700 mA	T_j = 125°C	

Switching

di/dt_{crit}	Critical rate of rise of on-state current		250 A/µs	Cont.	$V_D \le 0.67 \cdot V_{DRM}$ T_j = 125°C
			500 A/µs	60 sec.	I_{TRM} = 3000 A f = 50 Hz
					I_{FG} = 2.0 A t_r = 0.5 µs
t_d	Delay time		≤ 3.0 µs	$V_D = 0.4 \cdot V_{DRM}$	I_{FG} = 2.0 A t_r = 0.5 µs
t_q	Turn-off time		≤ 800 µs	$V_D \le 0.67 \cdot V_{DRM}$	I_{TRM} = 3000 A T_j = 125°C
				dv_D/dt = 20V/µs	V_R > 200 V
Q_{rr}	Recovery charge	min	4200 µAs		di_T/dt = -1 A/µs
		max	5200 µAs		

Triggering

V_{GT}	Gate trigger voltage	2.6 V	T_j = 25°C
I_{GT}	Gate trigger current	400 mA	T_j = 25°C
V_{GD}	Gate non-trigger voltage	0.3 V	$V_D = 0.4 \cdot V_{DRM}$
I_{GD}	Gate non-trigger current	10 mA	$V_D = 0.4 \cdot V_{DRM}$
V_{FGM}	Peak forward gate voltage	12 V	
I_{FGM}	Peak forward gate current	10 A	
V_{RGM}	Peak reverse gate voltage	10 V	
P_G	Gate power losses	3 W	

Thermal

$T_{j\,max}$	Max. junction temperature	125°C	
$T_{j\,stg}$	Storage temperature range	-40...150°C	
R_{thJC}	Thermal resistance junction to case	8 K/kW	Anode side cooled
		8 K/kW	Cathode side cooled
		4 K/kW	Double side cooled
R_{thCH}	Thermal resistance case to heat sink	2.6 K/kW	Single side cooled
		1.3 K/kW	Double side cooled

Analytical function for transient thermal impedance:

$$Z_{thJC}(t) = \sum_{i=1}^{n} R_i(1 - e^{-t/\tau_i})$$

i	1	2	3	4
R_i(K/kW)	3.1	0.7	0.3	
τ_i	0.8221	0.0623	0.0078	

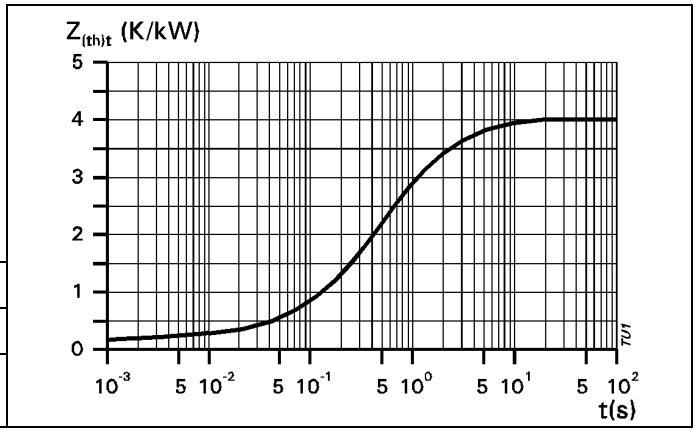


Fig. 1 Transient thermal impedance junction to case.

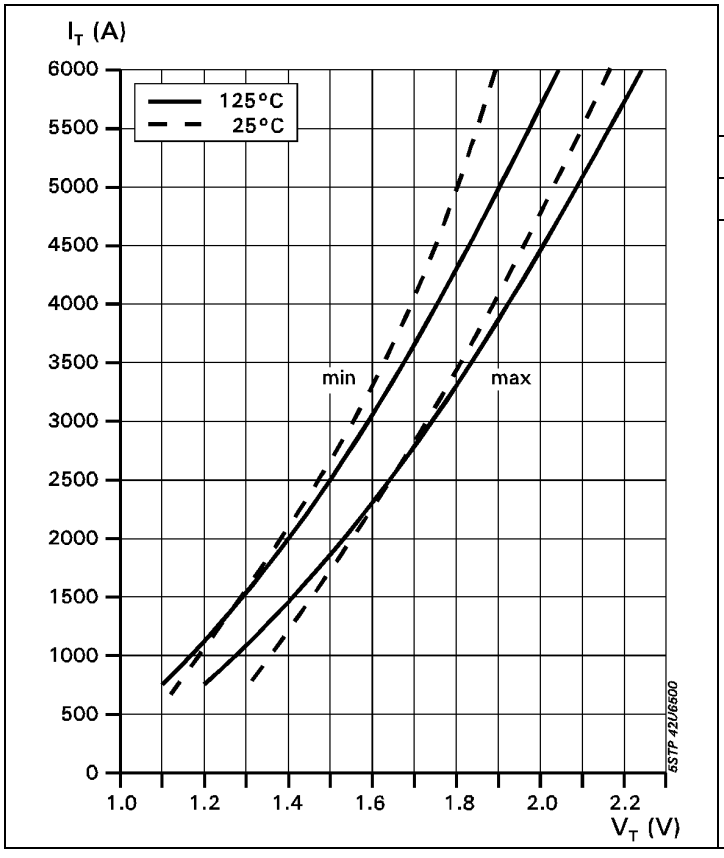


Fig 2. On-state characteristics.

On-state characteristic model:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{I_T}$$

Valid for i_T = 1000 – 6000 A

A	B	C	D
1.243	0.0000083	-0.108	0.024

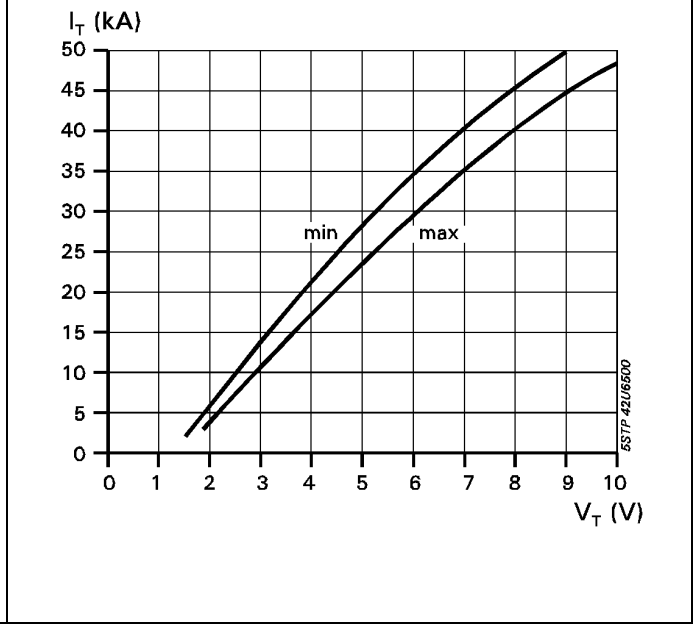


Fig. 3 On state characteristics.

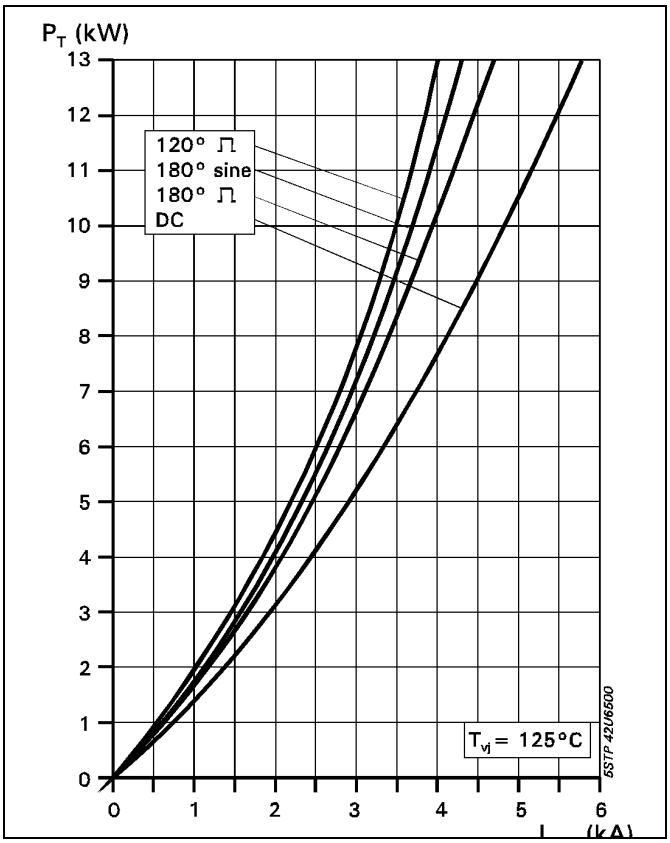


Fig. 4 On-state power dissipation vs. mean on-state current. Turn-on losses excluded.

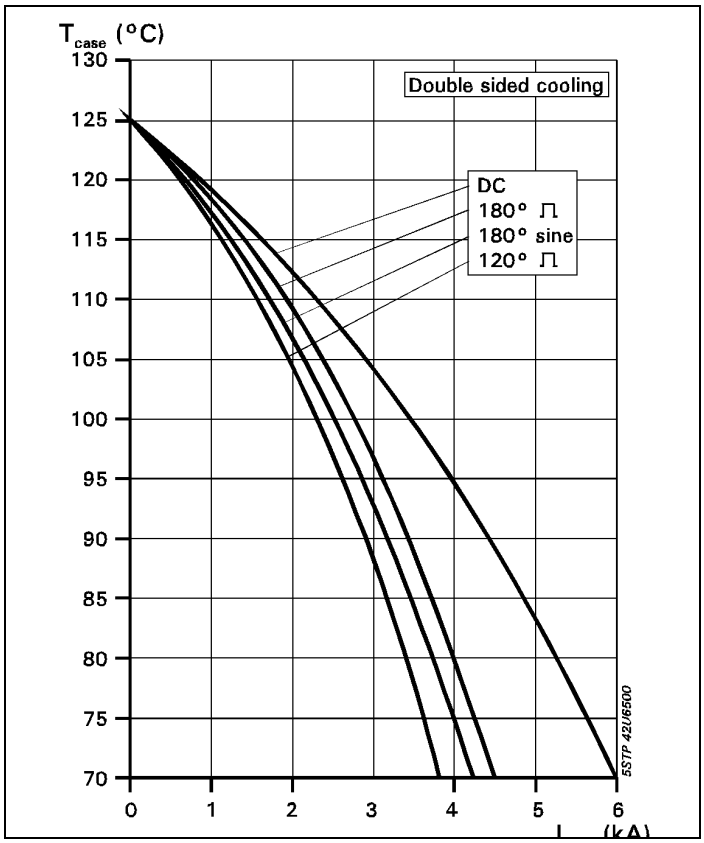


Fig. 5 Max. permissible case temperature vs. mean on-state current.

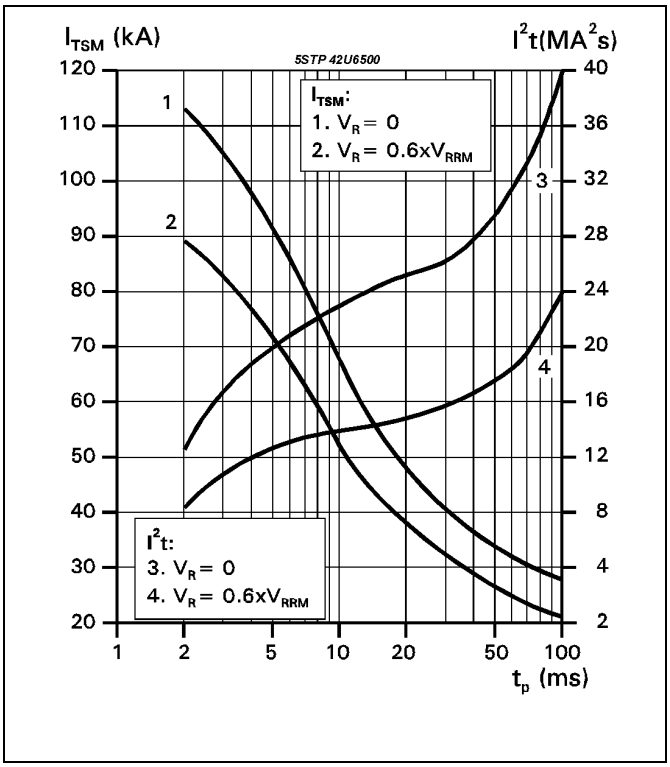


Fig. 6 Surge on-state current vs. pulse length. Half-sine wave.

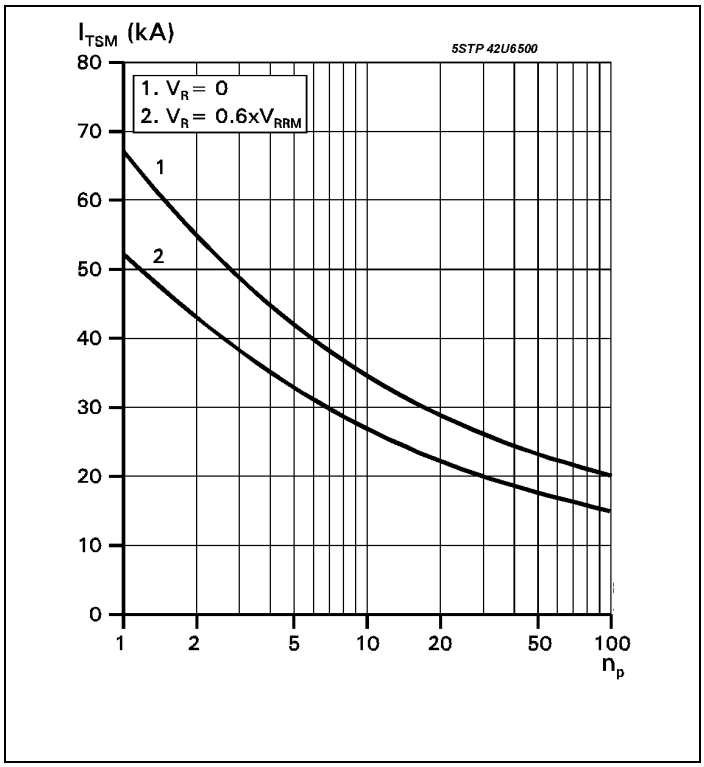


Fig. 7 Surge on-state current vs. number of pulses. Half-sine wave, 10 ms, 50Hz.

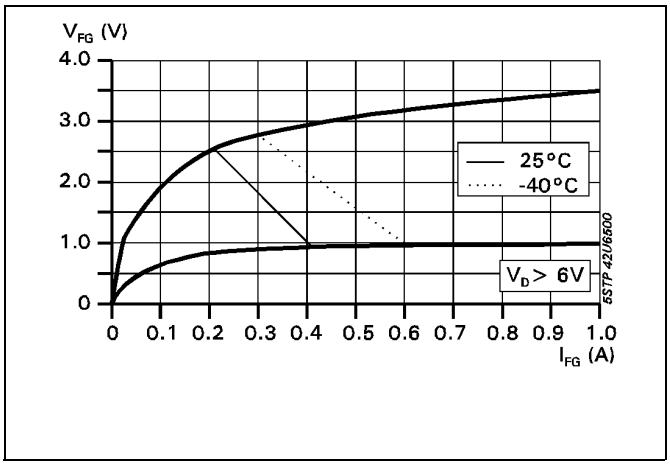


Fig. 8 Gate trigger characteristics.

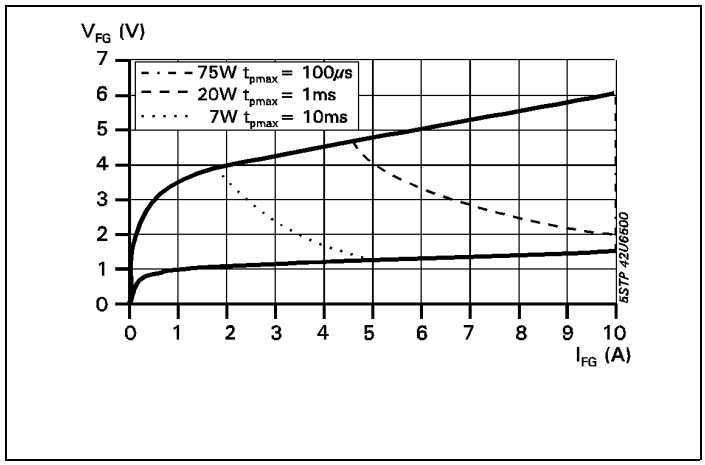


Fig. 9 Max. peak gate power loss.

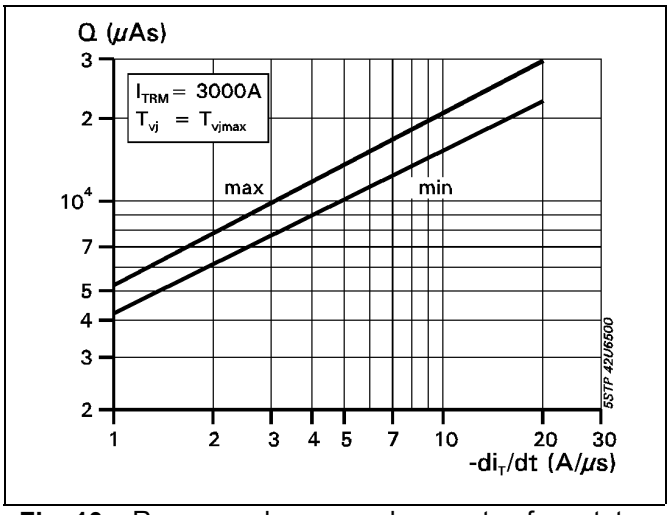


Fig. 10 Recovery charge vs. decay rate of on-state current.

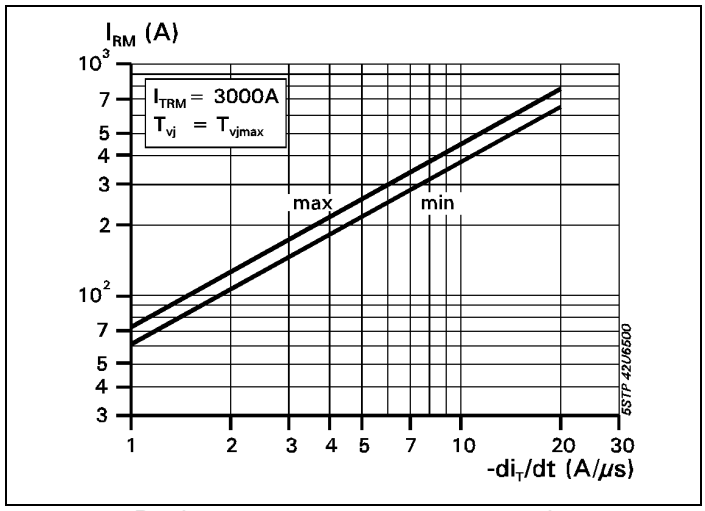


Fig. 11 Peak reverse recovery current vs. decay rate of on-state current.

Turn –off time, typical parameter relationship.

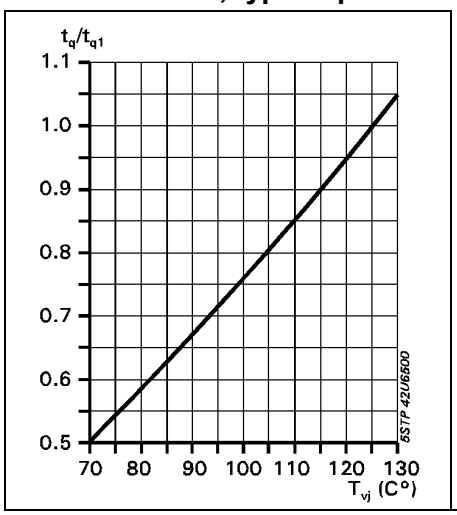


Fig. 12 $t_q/t_{q1} = f(T_j)$

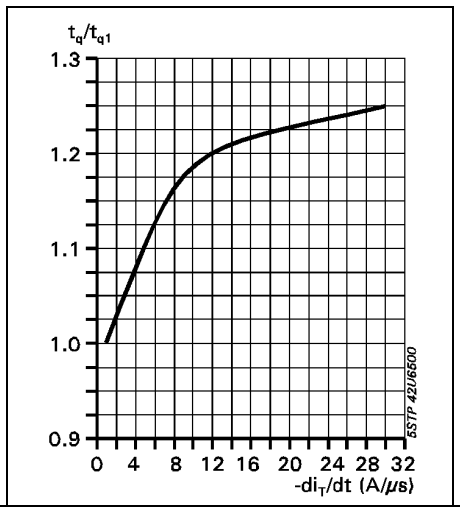


Fig. 13 $t_q/t_{q1} = f(-di/dt)$

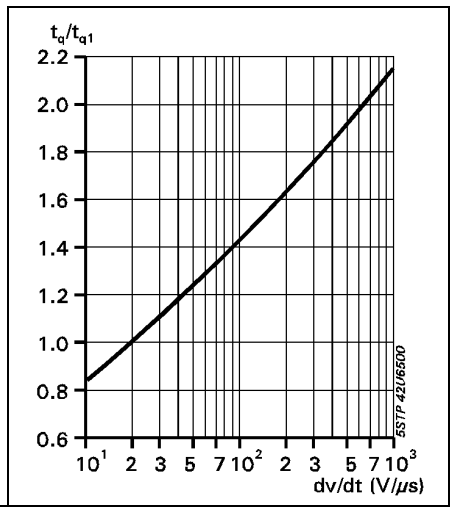


Fig. 14 $t_q/t_{q1} = f(dv/dt)$

$t_q = t_{q1} \bullet t_q/t_{q1}f(T_j) \bullet t_q/t_{q1}\ f(-di/dt) \bullet t_q/t_{q1}f(dv/dt)$

t_{q1} :at normalized values (see page 2)
t_q : at varying conditions

Turn-on and Turn-off losses

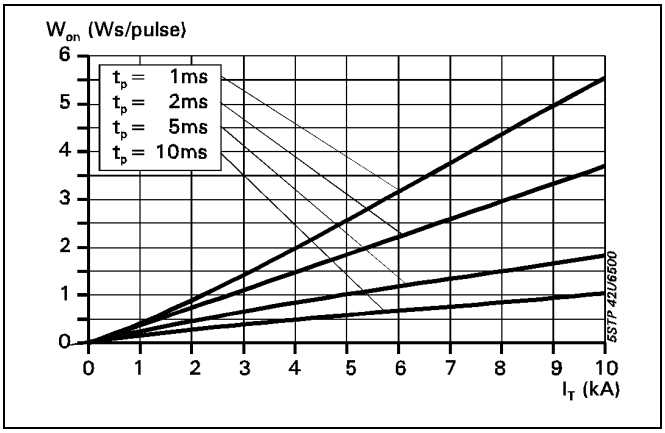


Fig. 15 $W_{on} = f(I_T, t_P)$, $T_j = 125°C$.
Half sinusoidal waves.

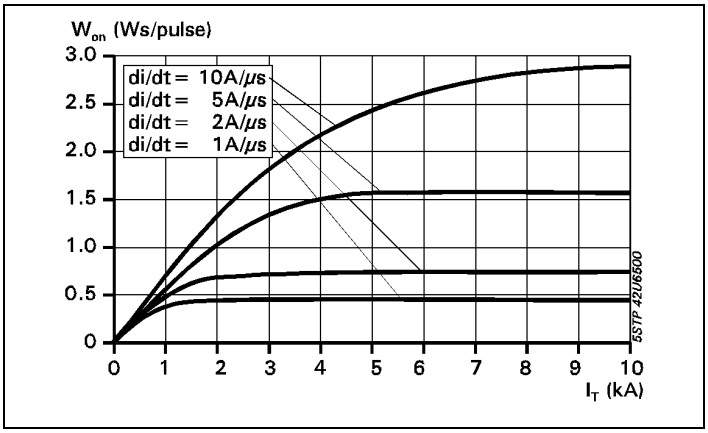


Fig. 16 $W_{on} = f(I_T, di/dt)$, $T_j = 125°C$.
Rectangular waves.

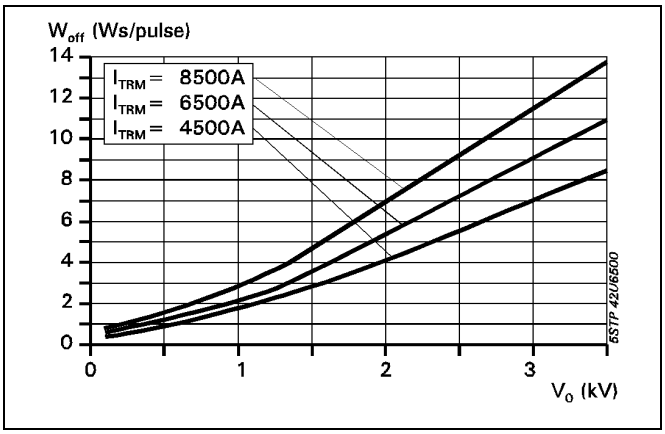


Fig. 17 $W_{off} = f(V_O, I_T)$, $T_j = 125°C$.
Half sinusoidal waves. $t_P = 10$ ms.

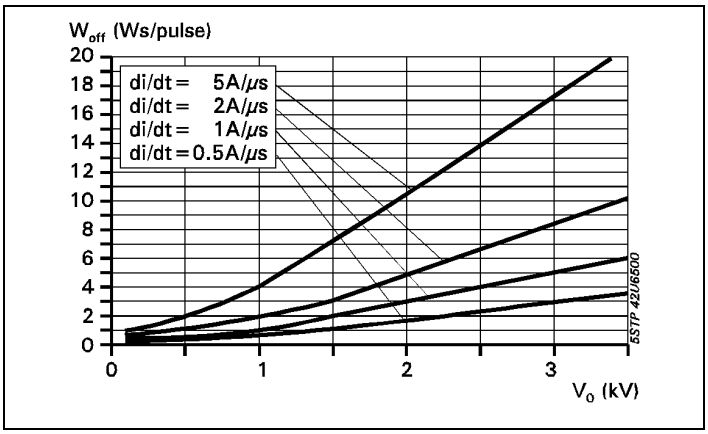


Fig. 18 $W_{off} = f(V_O, di/dt)$, $T_j = 125°C$.
Rectangular waves.

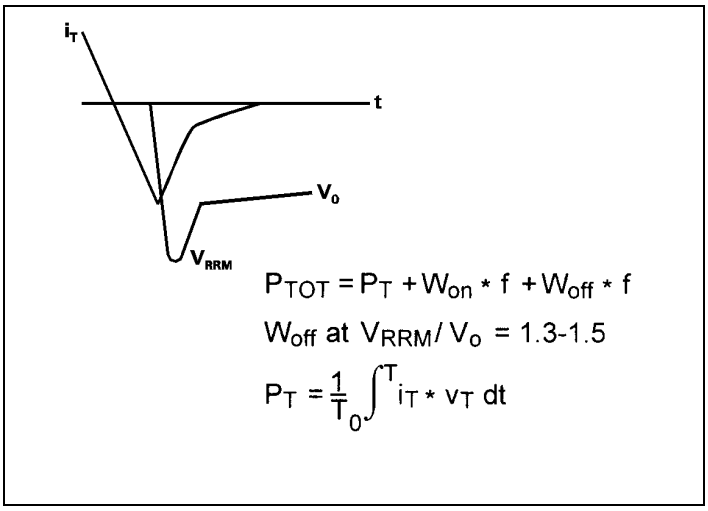


ABB Semiconductors AG
Fabrikstrasse 3
CH-5600 Lenzburg, Switzerland

Telephone +41 (0)62 888 6419
Fax +41 (0)62 888 6306

Doc. No. 5SYA 1043-01 August 00